Facile fabrication of one-dimensional Te/Cu <sub>2</sub> Te nanorod composites w improved thermoelectric power factor and low thermal conductivity	
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## 1. Figures

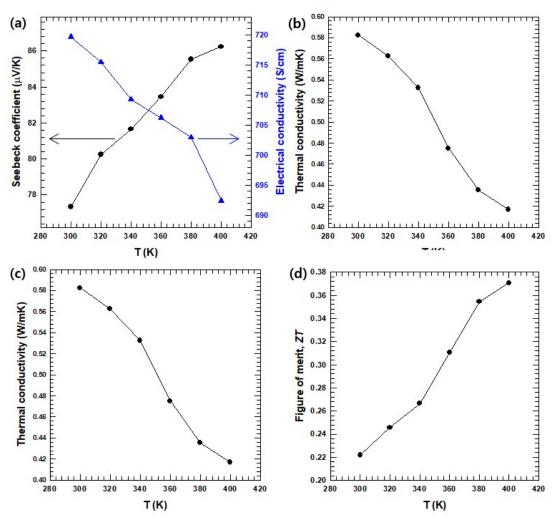


Fig. S1. (a) Seebeck coefficient, electrical conductivity, (b) thermal conductivity, (c) power factor and (d) ZT of 10 wt.% of Cu<sub>2</sub>Te/Te nanorod composites with various temperature

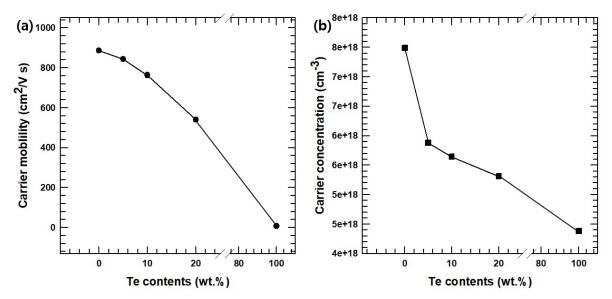


Figure. S2. (a) carrier mobility, and (b) carrier concentration of  $Cu_2Te/Te$  nanorod composites with various Te contents